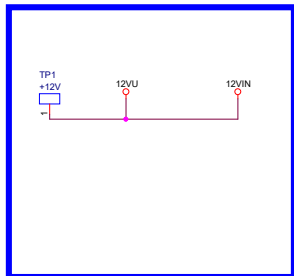
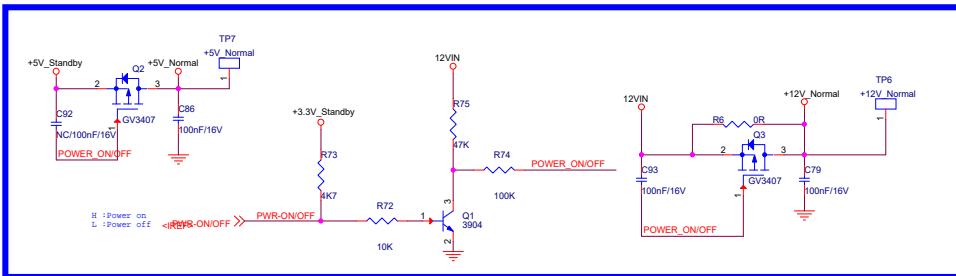


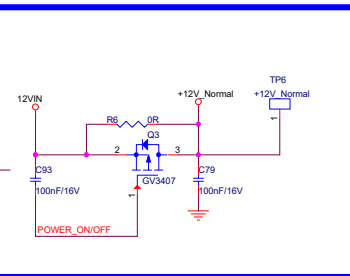
**POWER IN**



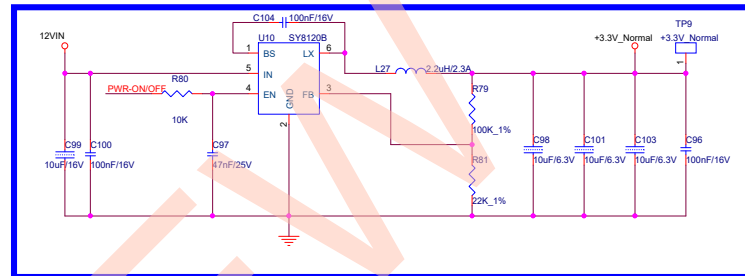
**5V Normal Power**



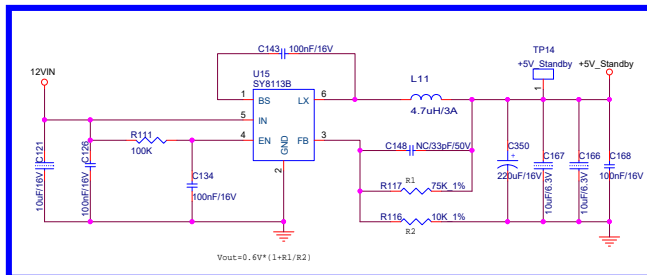
**12V Normal Power**



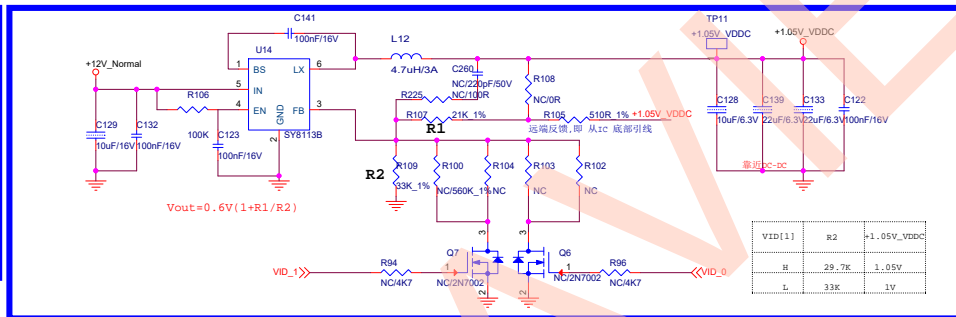
**3.3V Normal Power**



**5V Standby Power**

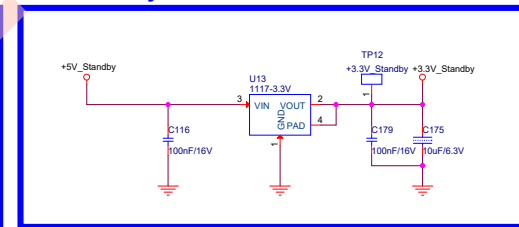


**VDDC Power**

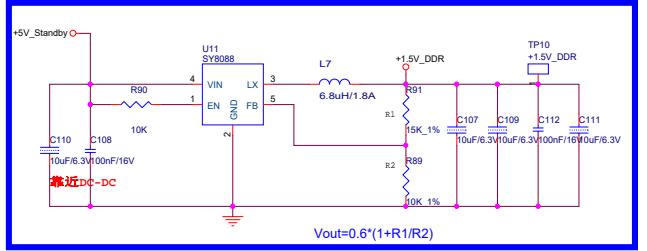


VID[1]	R2	+1.05V_VDDC
H	29.7k	1.05V
L	33k	1V

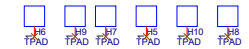
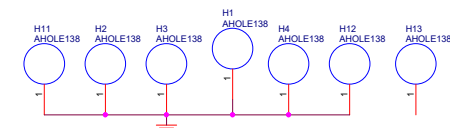
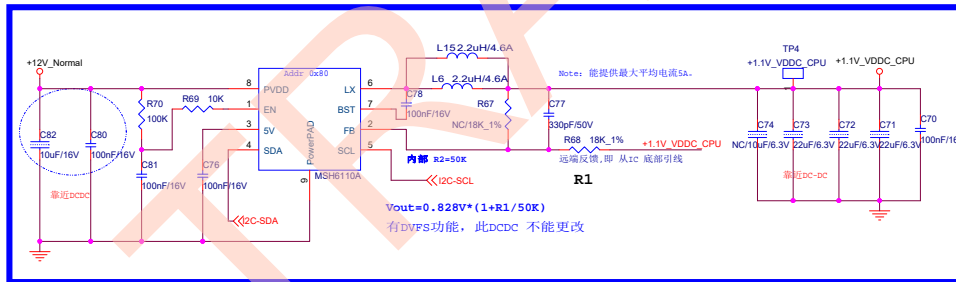
**3.3V Standby Power**

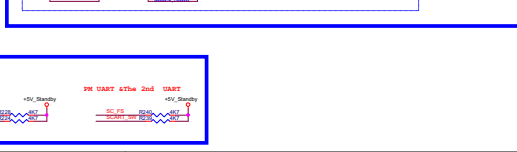
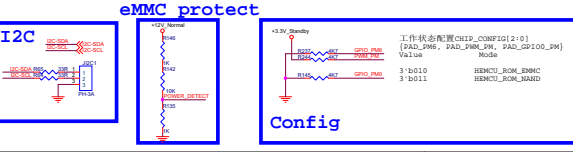
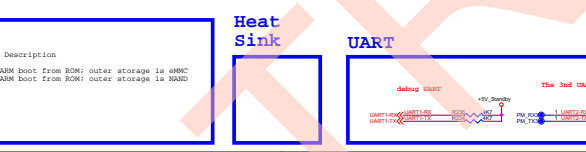
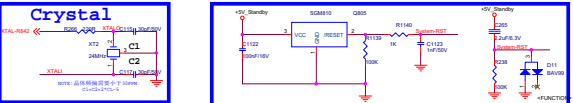
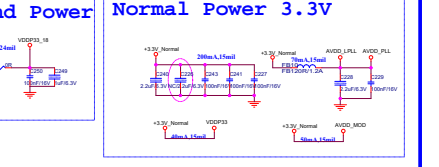
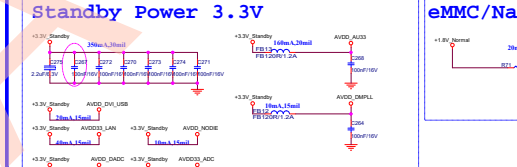
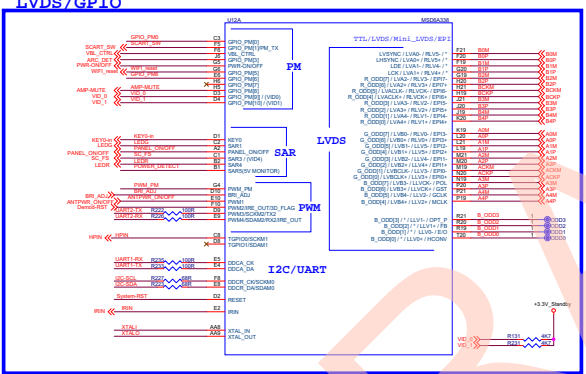
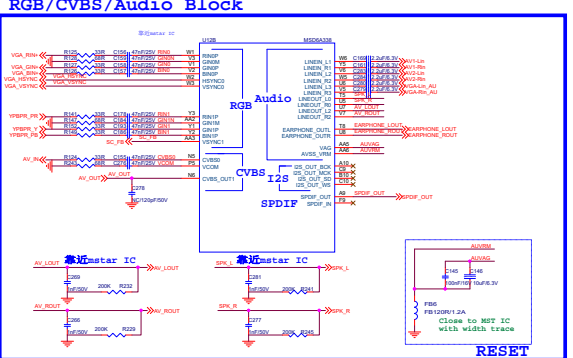
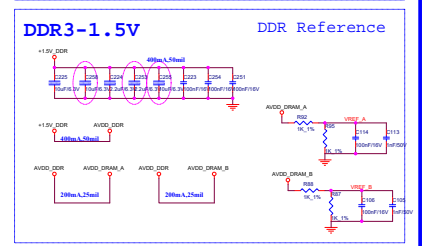
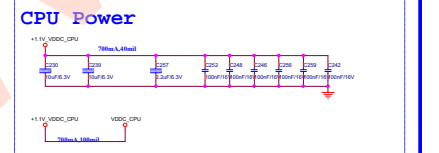
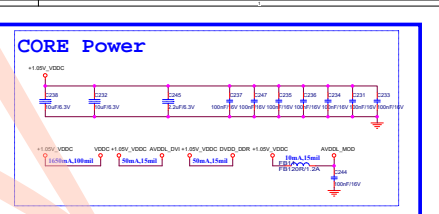
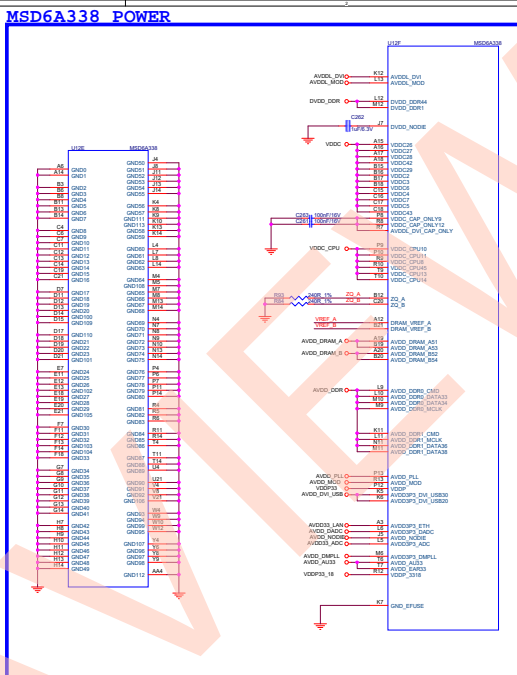
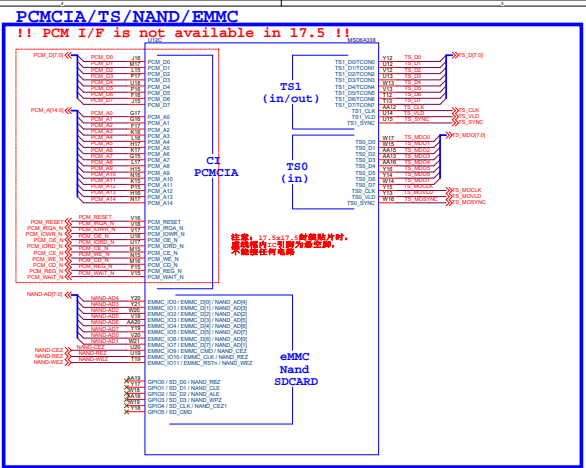
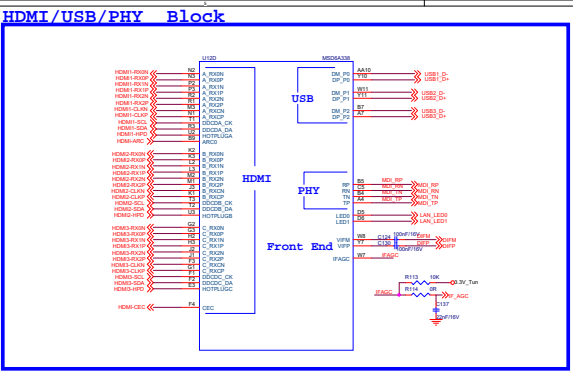


**1.5V Normal Power for DDR3**



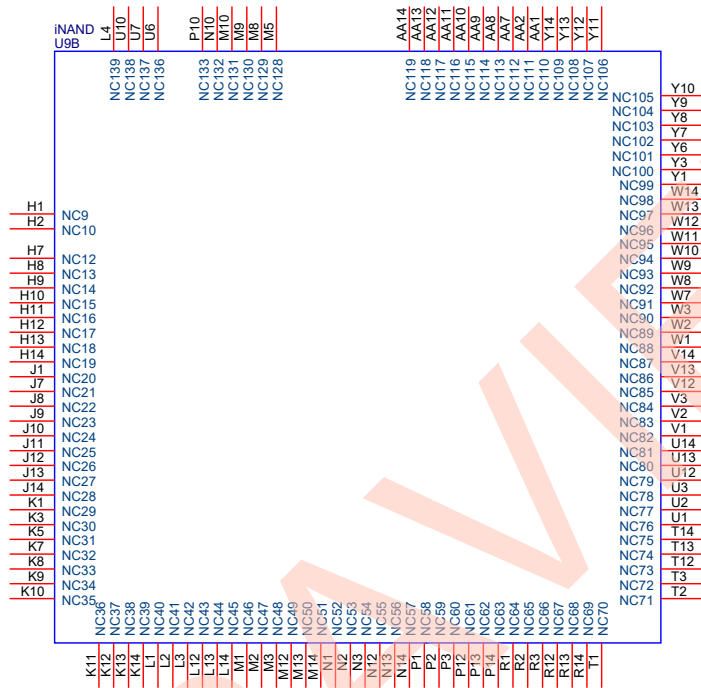
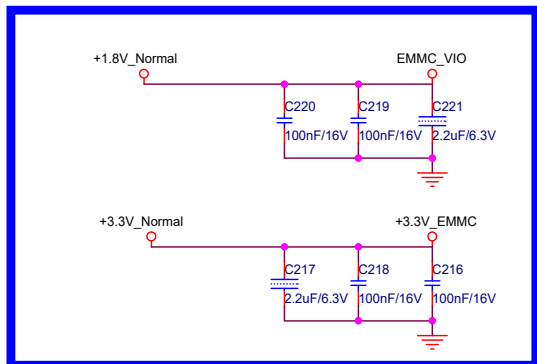
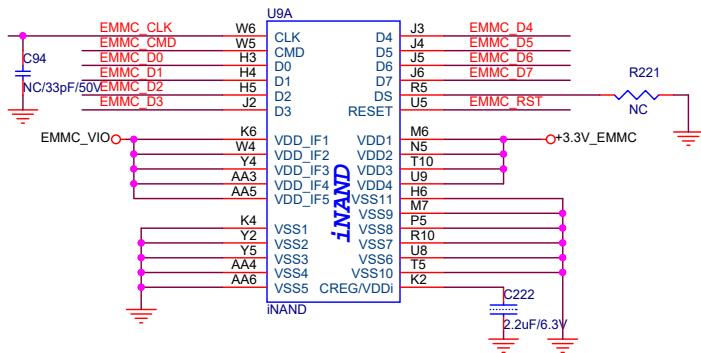
**VDDC\_CPU Power**



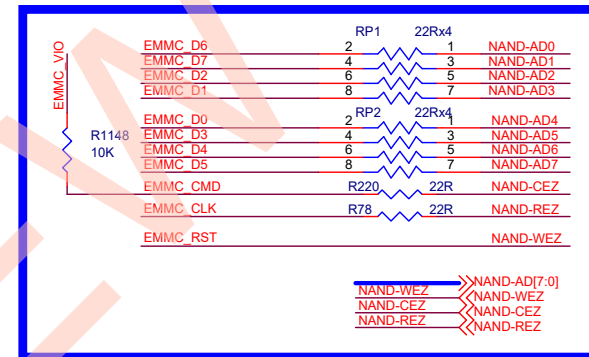


Value	Mode	Description
3'b010	MEMO_ROM_ENMC	ARM boot from ROM; outer storage is eMMC
3'b011	MEMO_ROM_NAND	ARM boot from ROM; outer storage is NAND

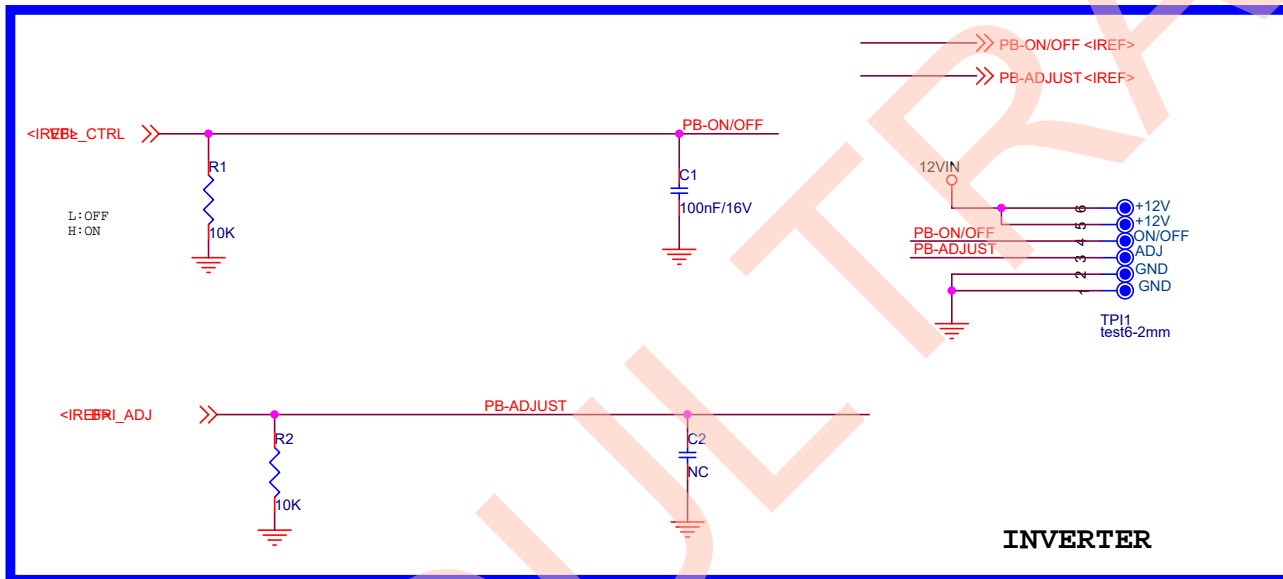
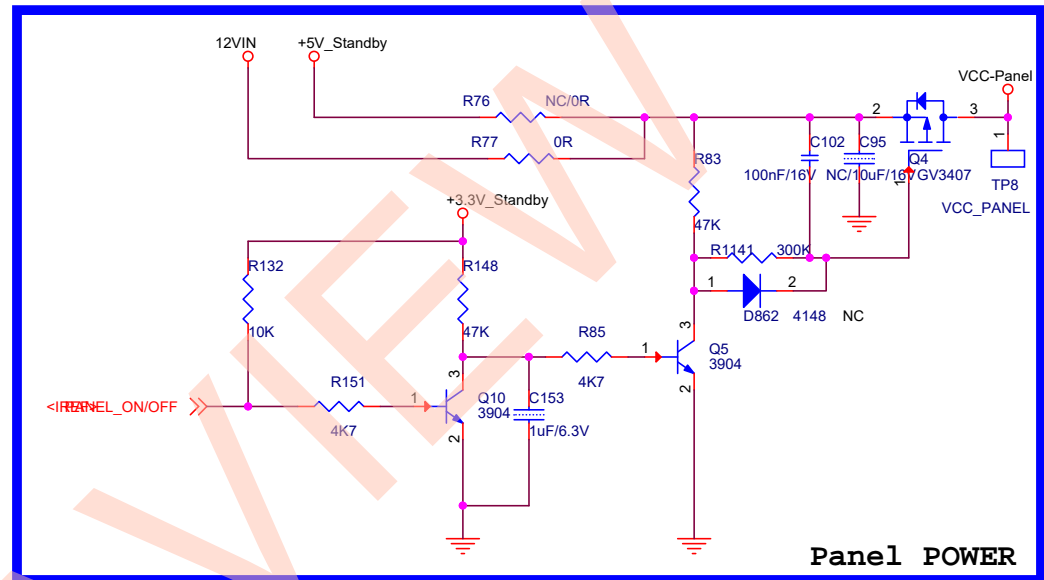
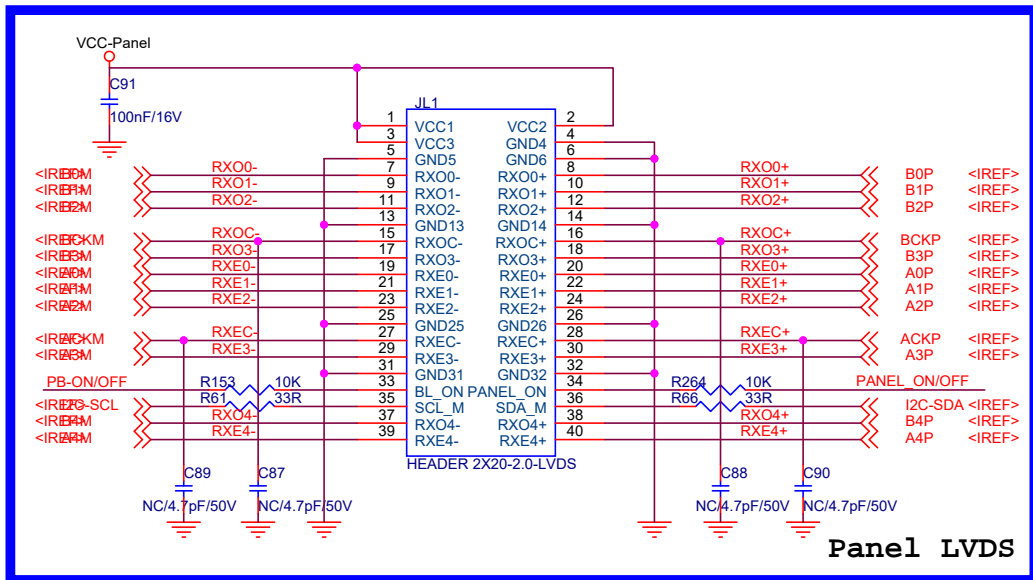
# eMMC



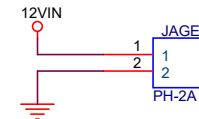
# NET



Cultraview		Title <b>EMMC</b>	
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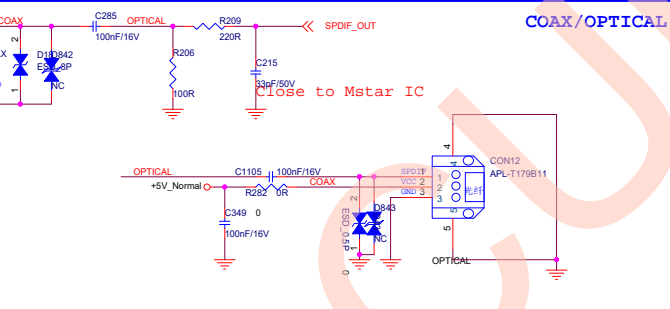
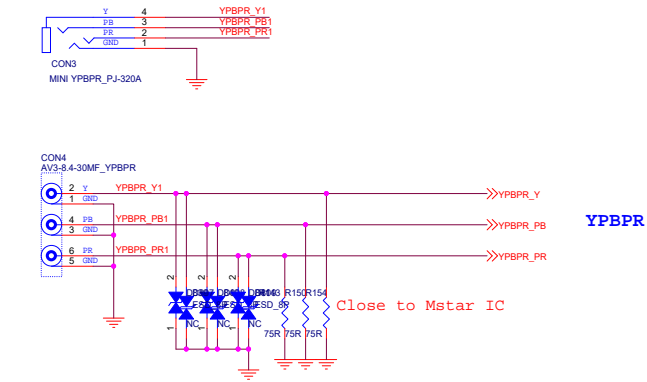
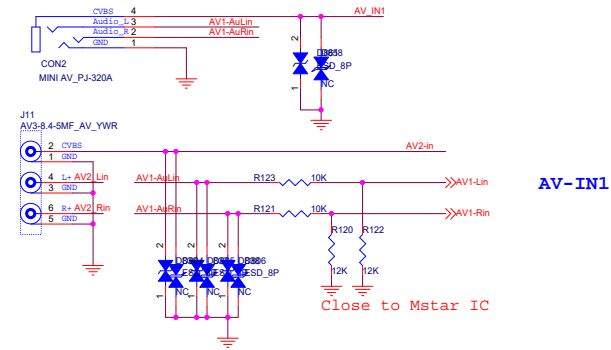


预留一个两PIN的座子给工厂老化用

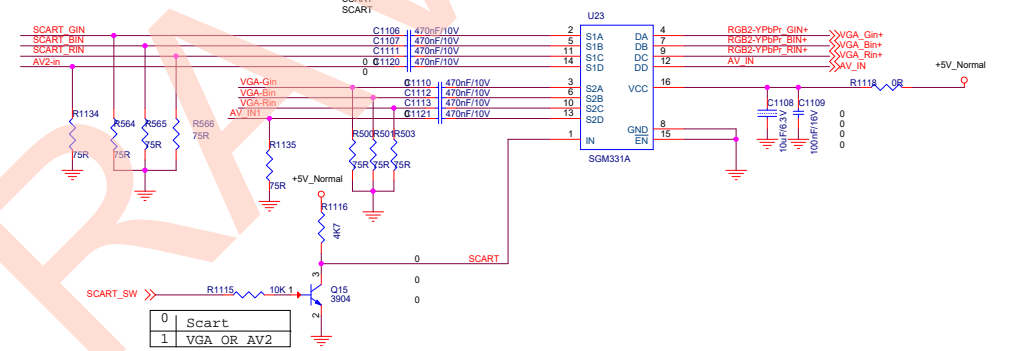
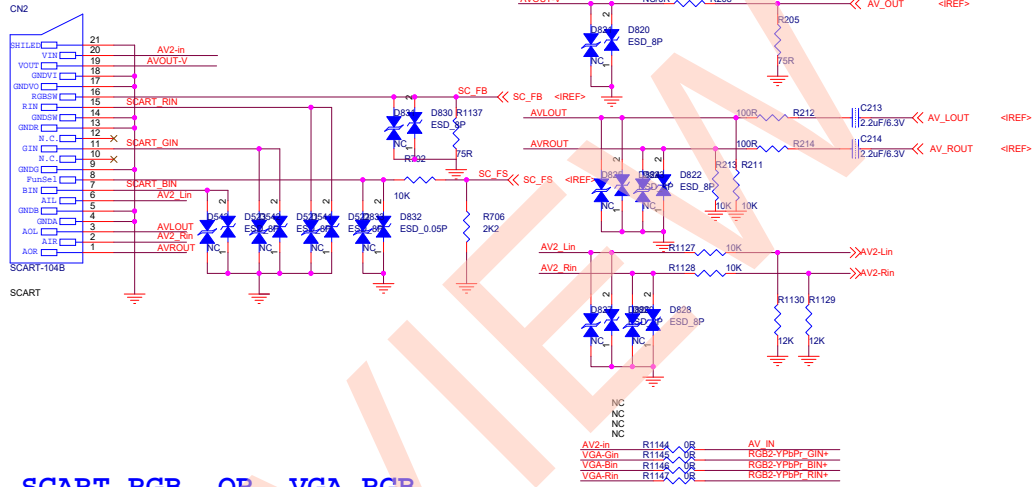


		<b>Title</b> <b>PANEL</b>	
<b>Size</b> Custom	<b>Document Number</b> <Doc>	<b>Rev</b> <1.5>	
<b>Date:</b> Monday, July 11, 2016		<b>Sheet</b> 5 of 14	

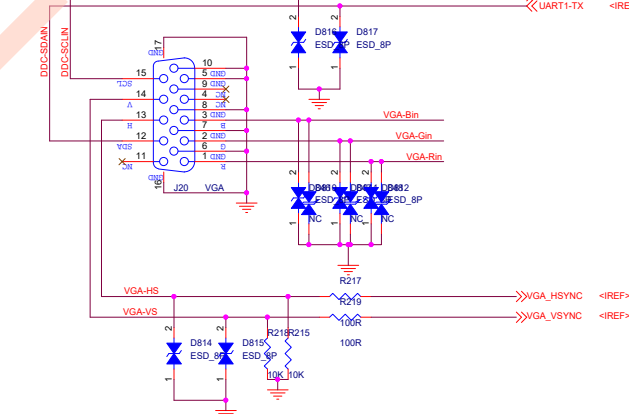
# YPBPR & AV & COAX Out



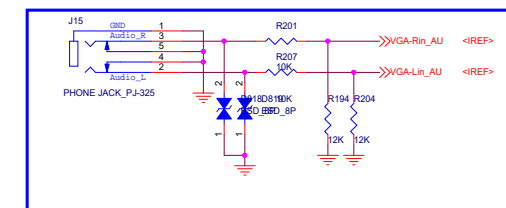
# SCART



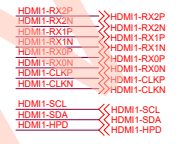
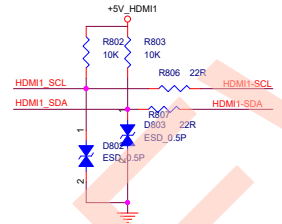
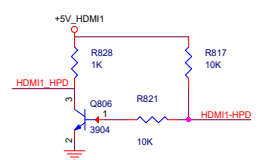
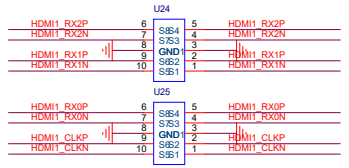
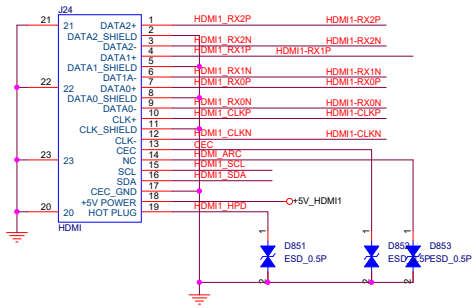
# VGA



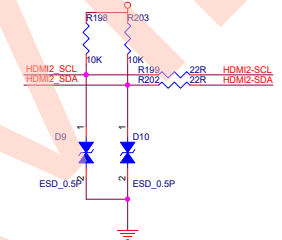
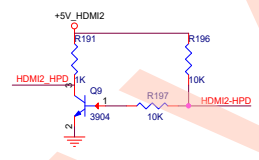
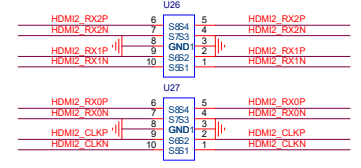
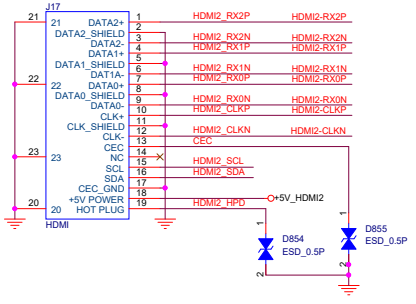
# PC AUDIO



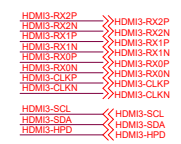
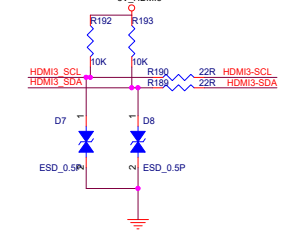
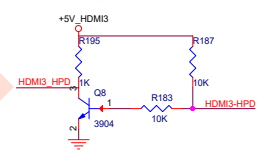
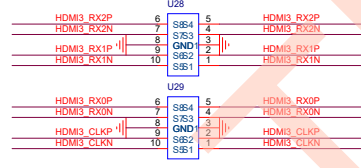
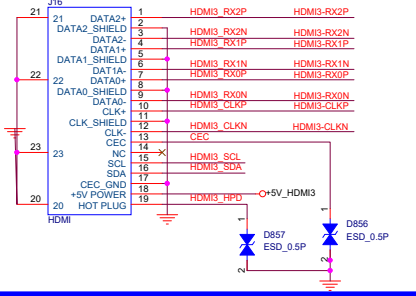
### HDMI 1 ( ARC )



### HDMI 2



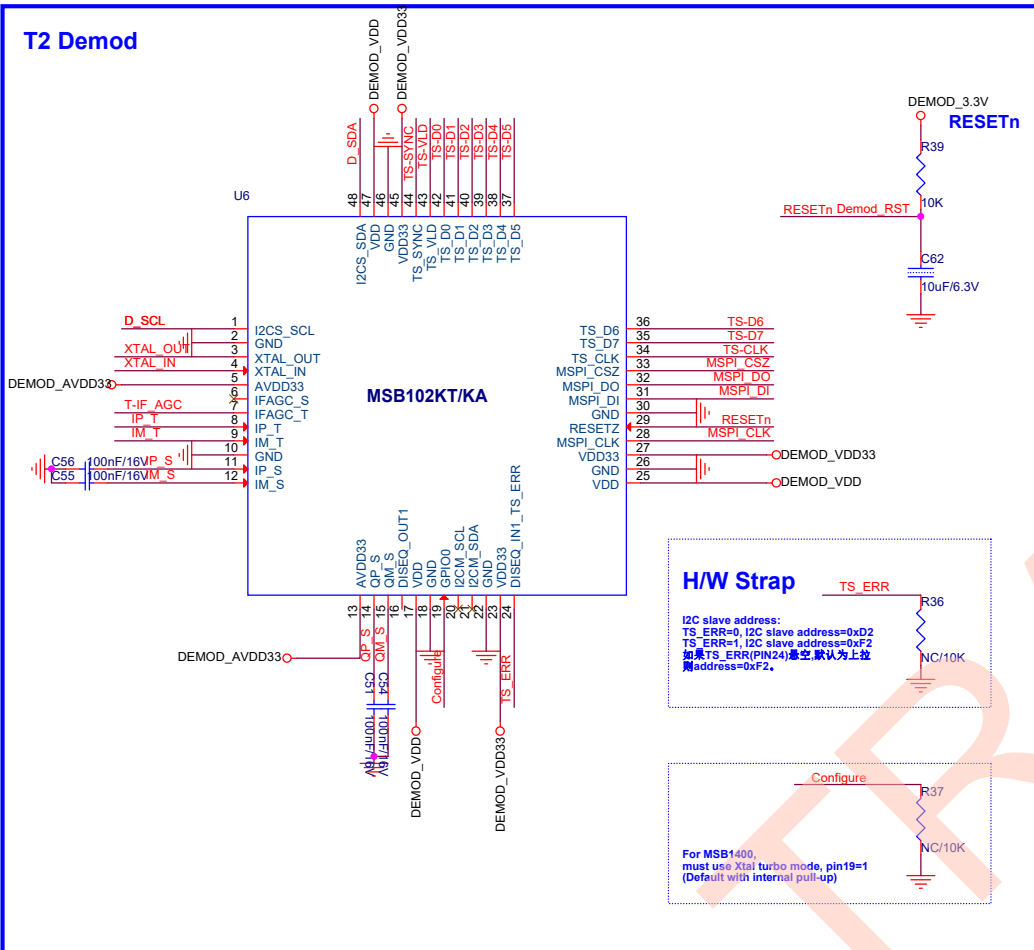
### HDMI 3



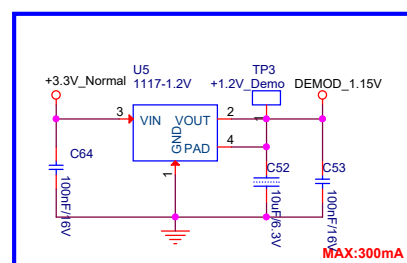
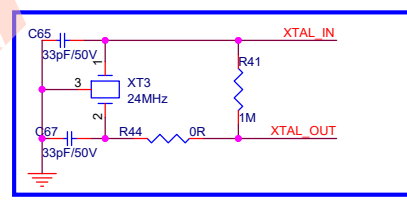
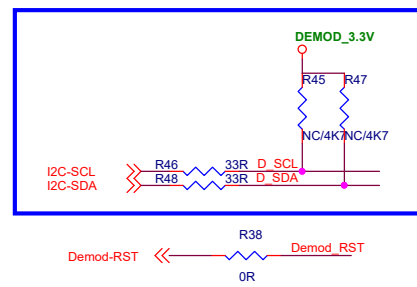
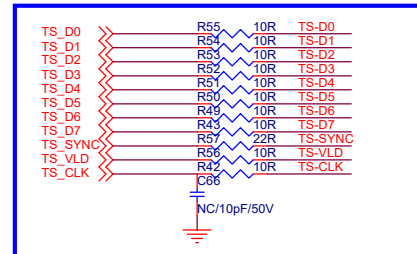
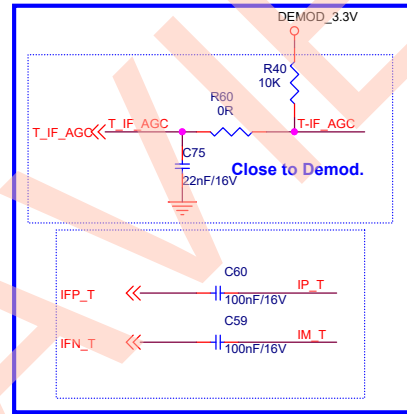
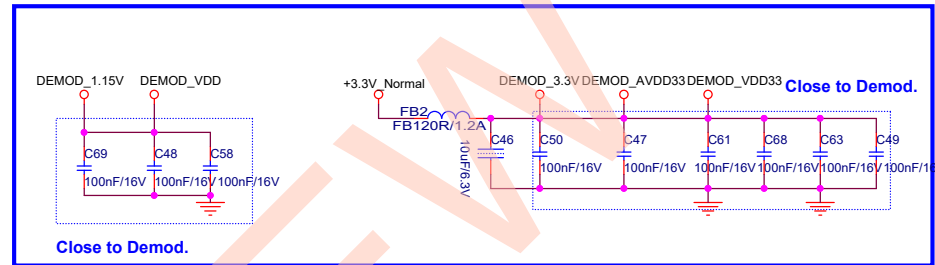
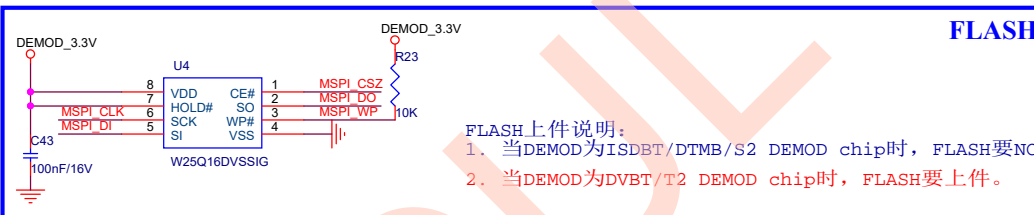
### CEC & ARC



### T2 Demod



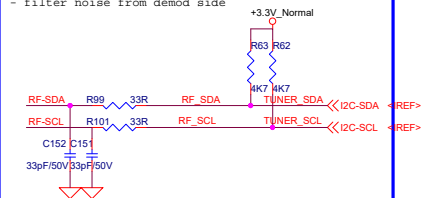
### FLASH



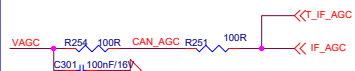
<b>Cultraview</b>		Title <b>T2 Demod MSB102KT</b>	
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### I2C Interface Filter

- filter noise from demod side



### IFAGC Circuit

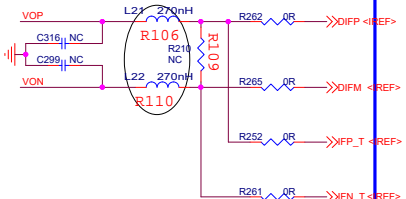


- R103 and R106 are related to Demod side's IFAGC design. Sometime need to fine tune for different Demod.  
- Following IFAGC TBD table is common suggestion.

IFAGC TBD table

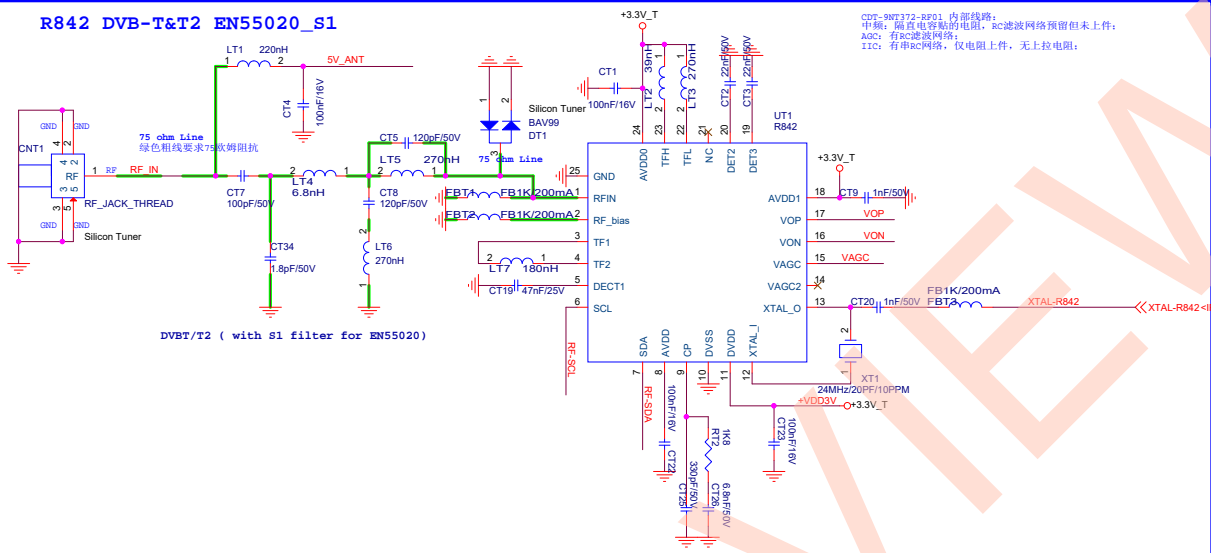
Open drain	R103=100R
Push Pull	R103=10KR

### IF Interface Filter



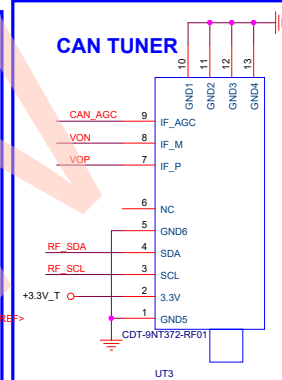
- C124, C130 are optional for AC coupling, short it if Demod side is already AC coupled.  
- recommend to reserve R106, R110, R109 to filter noise from demod side.

### R842 DVB-T&T2 EN55020\_S1

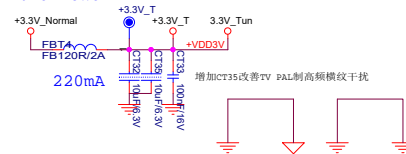


CDT-9NT372-RF01 内部线路:  
中频: 隔直电容的电阻, RC滤波网络预留但未上件;  
AGC: 有RC滤波网络;  
IIC: 有串RC网络, 仅电阻上件, 无上拉电阻;

### CAN TUNER

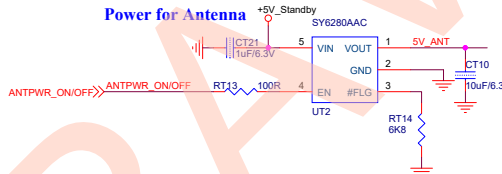


### Tuner Power



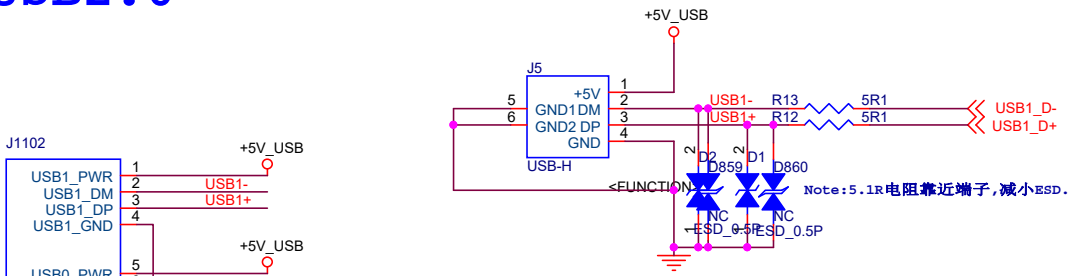
- (1) +VDD3V input voltage tolerance must be under +5%
- (2) +VDD3V input ripple must be under 30mVpp
- (3) Using LDO for +VDD3V is recommended

### Power for Antenna

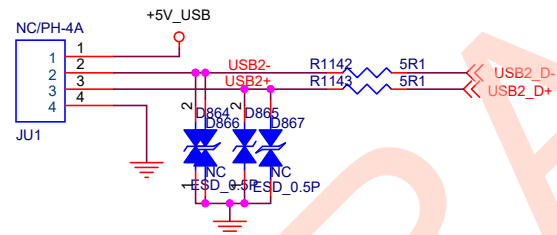




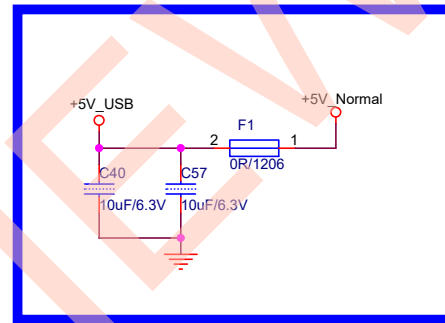
# USB2.0



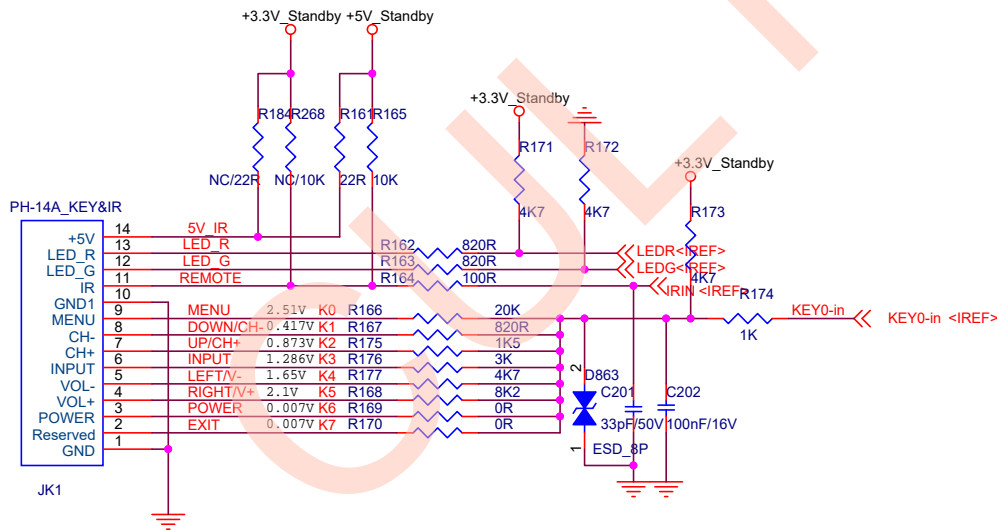
## INNER USB



# USB2.0 Power

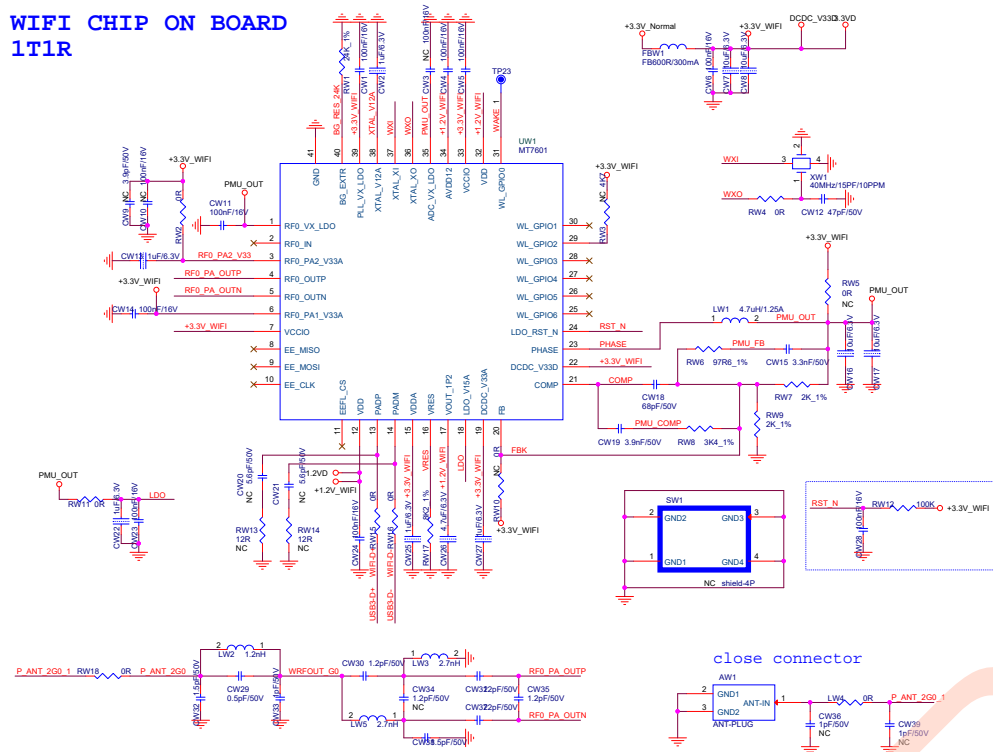


# KEY/IR/LED

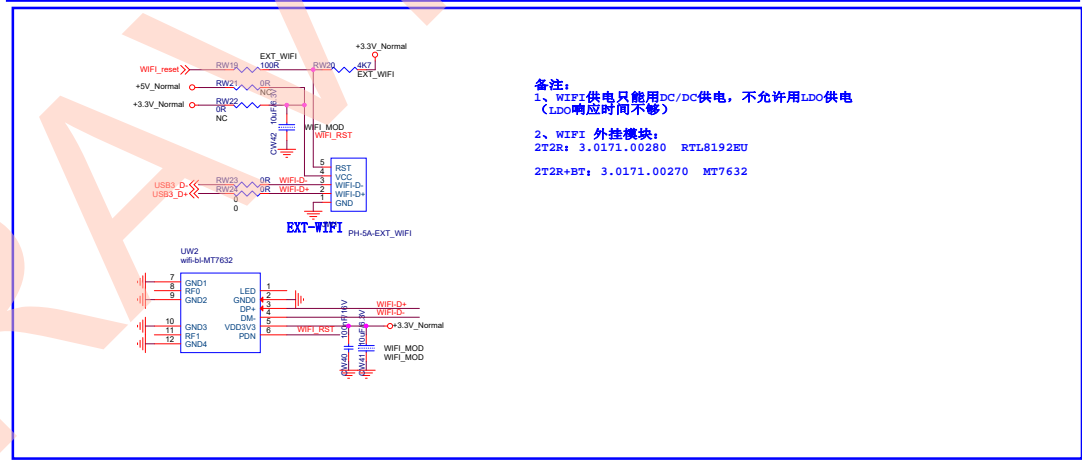
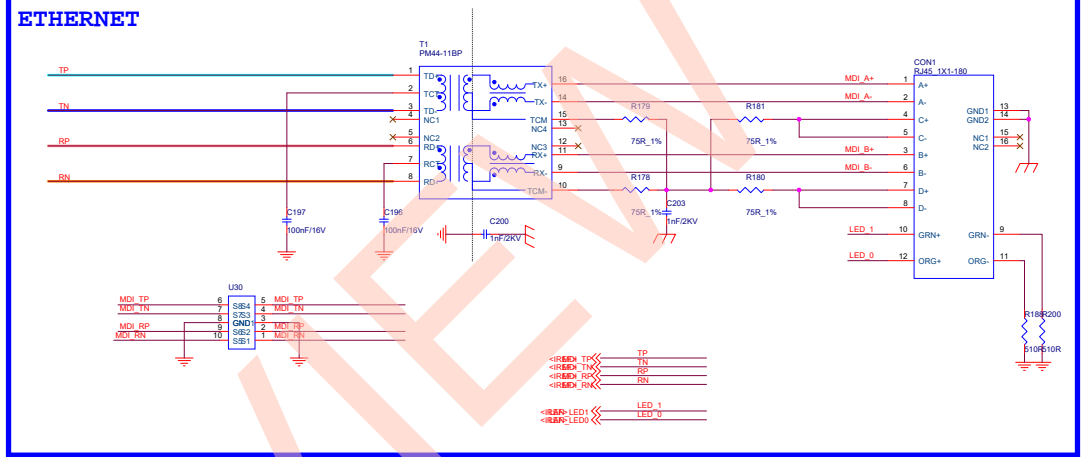


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# WIFI CHIP ON BOARD 1T1R



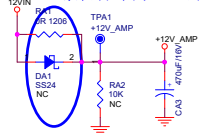
# ETHERNET



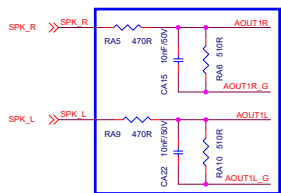
- 备注:**  
 1、WIFI供电只能用DC/DC供电，不允许用LDO供电  
 (LDO响应时间不够)  
 2、WIFI 外挂模块:  
 2T2R: 3.0171.00280 RTL8192EU  
 2T2R+BT: 3.0171.00270 MT7632

# 三合一电源功放固定用12v供电2x8W电路

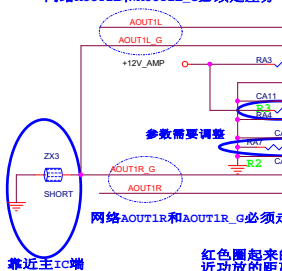
默认装0欧姆 1206封装电阻



参数根据芯片方案而定, 靠近主IC摆放



网络AOUT1L和AOUT1L\_G必须走差分



参数需要调整



网络AOUT1R和AOUT1R\_G必须走差分

红色圈起来的两组电容靠近功放的距离基本相同

## 替代料部分:

- MP7752GF-Z (3.0102.84490) 输入电压在5V---18V之间
  - PVCC到PIN7之间串的10R电阻R3删除
  - PLIMIT的电压需要调整R1=33K, R2=12K
  - 电阻R3上需要装10欧姆电阻, 封装0603
- OB6220 (3.0102.81480) 输入电压在6V---20V之间
  - PLIMIT的电压需要调整R1=10K, R2=7.5K
  - 电阻R3上需要装10欧姆电阻, 封装0603
- TPA3110LD2 (3.0102.61300) 输入电压8V---26V之间
  - PLIMIT的电压需要调整R1=10K, R2=7.5K
  - 电阻R3上需要装10欧姆电阻, 封装0603

## 注意事项:

- 音频输入LAYOUT走线必须差分走线。地信号的差分线必须尽可能靠近主IC。
- 功放芯片的第7脚上的1uF电容的地脚必须尽快回到功放芯片第8脚。1uF电容地脚不需要与其他地线打孔连接。
- 功放的输入音频信号线上的隔直电容容易受到温度影响, 所以放置位置需保持两组电容靠近功放的距离基本相同
- 功放左右声道电感尽量远离。这2组电感必须保证距离在4.5mm以上, 中间夹地线打孔。避免左右音频串音。且Layout时同一边两个电感绕线方式要相对
- 模拟信号尽量远离功放电感避免干扰, 距离最少保持20mm以上
- 功放MUTE控制脚默认上电瞬间电平为低电平, 控制电路的电平根据芯片不同, 可修改。
- 固定26db放大倍数, 可根据客户对功率限制做改动。
- 默认不装SK24, 用0R替代。
- 现在对功放部分的电感要求兼容磁珠, 电感封装使用WSA43-6R8M-RB, 磁珠封装PB0805
- 三合一电源, 功放只接12V供电。原来下电爆音电路可省
- 三合一电源一体板功放位置在左下角时注意电感距离pcb板边20mm以上。以避免ac线靠近功放电感引起传导超标。
- 当输出网络上使用磁珠的时候在SPEAKER\_L+和AMP\_LOUT-网络, SPEAKER\_R+和AMP\_ROUT-网络之间加RC电路改善EMI; 具体追加CA32 CA33 RA27 RA28-----更新: 20160223

## 注意事项:

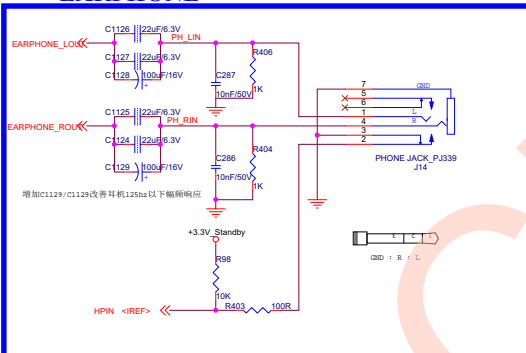
- 这几颗物料带有逻辑关系, 在Module项里, 要求导出BOM时一起导出该属性以便好确认BOM中的相关性定义是否正确
- LA1, LA4的第一脚接功放IC端, 第二脚为输出端。LA2, LA3的第二脚接功放IC端, 第一脚为输出端不能更改。这样做的目的是可以在Layout时约束电感的摆放, 控制绕线电感的磁场使相抵消可以有效改善EMI及底噪

gain0, gain1调整TPS3110的增益, 逻辑图如下:

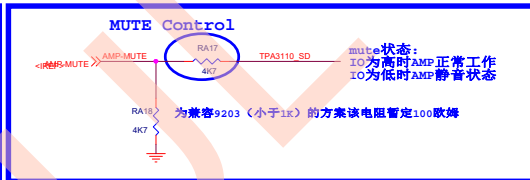
gain1	gain0	AMPLIFIER GAIN (dB)	INPUT IMPEDANCE
0	0	20dB	60k
0	1	26dB	30k
1	0	32dB	15k
1	1	36dB	9k

输入阻抗越大干扰效果越好

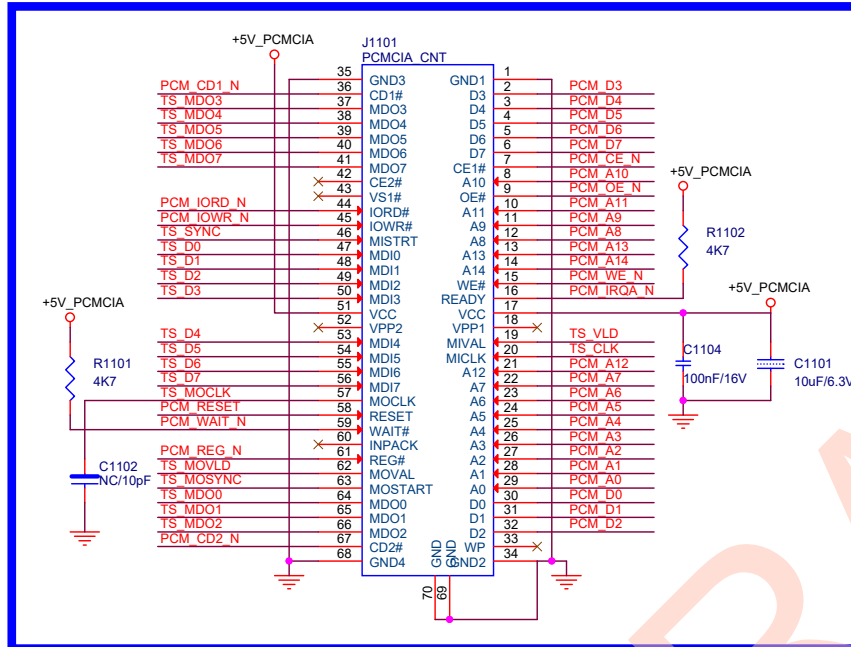
## EARPHONE



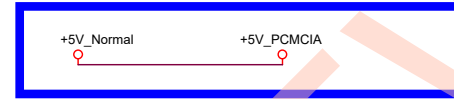
## MUTE CONTROL



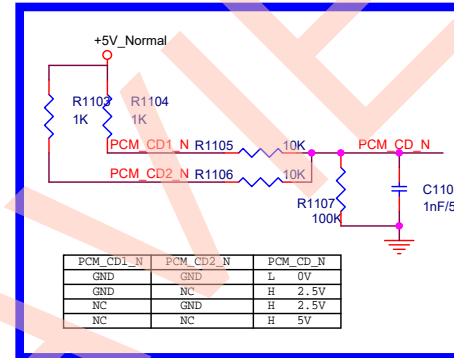
## PCMCIA



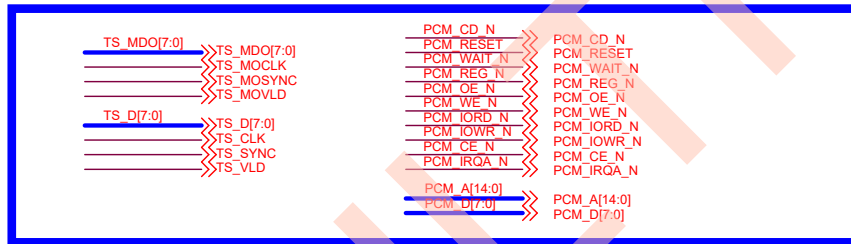
## PCMCIA POWER



## CARD DETECT



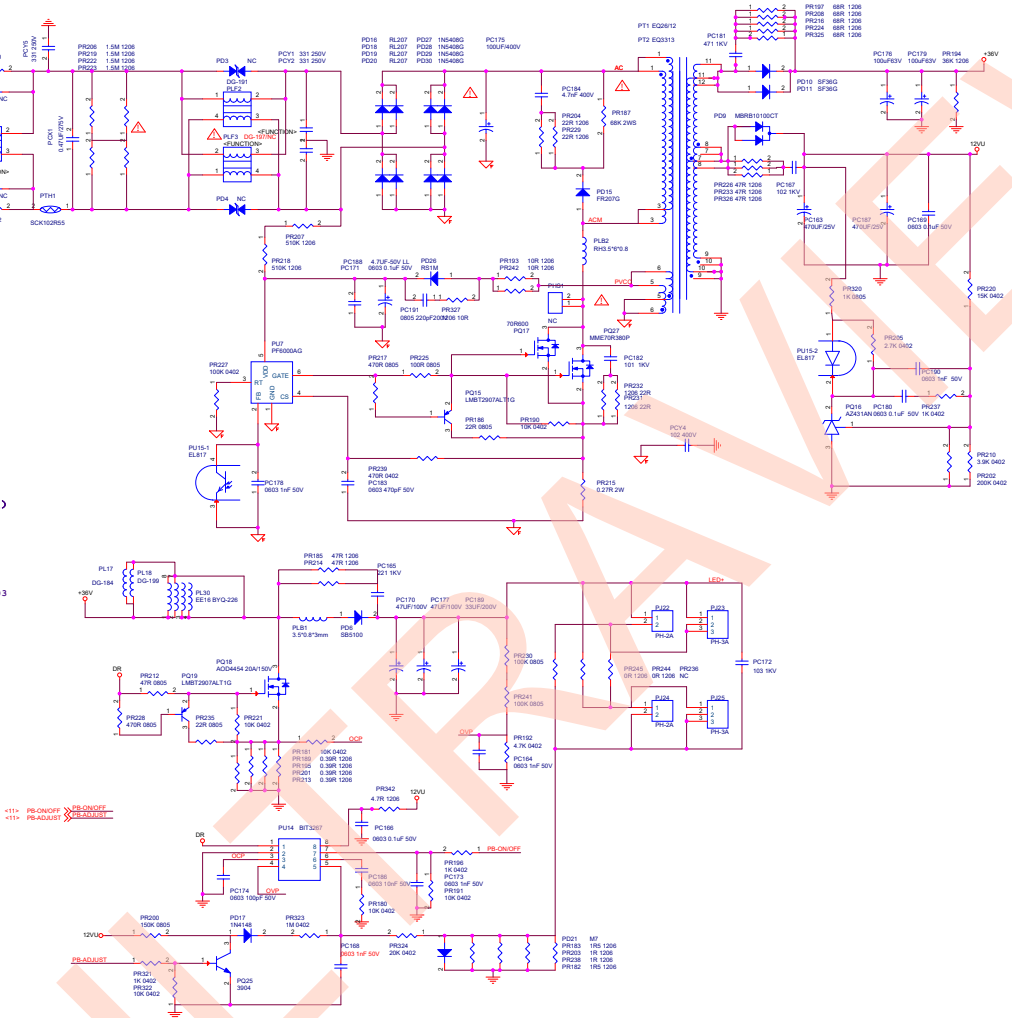
## NET



<b>Cultraview</b>		Title <b>PCMCIA &amp; CA</b>	
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- PTH1: 统一-SCK102R55;
- FVR1: 14D561K/NC; 视客户是否要求增加而定
- PR206/PR219/PR222/PR223: 1.5M/1206 ;
- PLP4: UC15C;
- PD16, PD18, PD19, PD20: RL207; 高压地区
- PD27, PD28, PD29, PD30: 1N54080; 低压地区
- PR187: 68K/2W;
- PR193/PR242: 10K/1206;
- PR137: 10K/1206;
- PC191: X7R 470pF/200V 0805
- 非必要时NC
- PC188: LL 4.7uF/50V;
- PC173: X7R 0.1uF/50V 0603
- PR227: 100K/0402;
- PC178: X7R 1nF/50V 0603 ;
- PR225: 100R/0805; (68R-100R满足温升前提下尽量大)
- PR190: 10K/0402
- PR217: 470R/0805;
- PR186: 22R/0805;
- PC15: LMBT2907
- PR239: 470R/0402;
- PC183: X7R 470nF/50V 0603
- 视客户实际使用情况选择, 定封装电阻0402, 电容0603
- PR215: 0.27R/2W;
- PC27: 高压地区70R380; 低压地区60R290



- PC181: 47uF/16V;
- PR197, PR208, PR216, PR224, PR325: 68R/1206;
- PC167: 102/1KV;
- PR226/PR233/PR326: 默认3只47R/1206. 根据实际调试而定
- PC169: X7R 0.1uF/50V 0603
- PR220: 15K/0402 F
- PR202: 200K/0402 F
- PR210: 3.9K/0402 F
- PR320: 1K/0805; 封装0805, 阻值视主控IC而做调整
- PR205: 2.7K/0402
- PR237: 1K/0402
- PC180: X7R 0.1uF/50V 0603; 最大不超过0.47uF
- PC190: X7R 1nF/50V 0603
- 虚拟负载正常情况下, 主要用于背光功率较大, 为满足温升要求而防止偏振时背光灯条被点亮的情况。
- PL30: BYQ-226
- PC165: 221/1KV;
- PR185/PR214: 47R/1206
- PC170/PC177: 47uF/100V;
- PC189: 330P/200V
- PR192: 4.7K/0402固定
- PC164: X7R 1nF/50V 0603
- PR210/PR241: 封装0805, 根据背光电压设置OV点
- PR236/PR244/PR245: 0R/1206
- PR212: 47R/0805;
- PR221: 10K/0402
- PR228: 470R/0805;
- PR235: 22R/0805;
- PC19: LMBT2907
- PR189/PR195/PR201/PR213: 0.39R/1206
- PR181: 20K/0402; 10K/0402
- 升压电感温升满足, 建议选10K/0402, 有利于EMI
- PC166: X7R 0.1uF/50V 0603
- PC174: X7R 100pF/50V 0603
- PC173: X7R 1nF/50V 0603
- PR194: 1K/0402;
- PR191: 10K/0402
- PC186: X7R 10nF/50V 0603;
- PR180: 10K/0402
- 以实际调试为准
- PR321: 1K/0402;
- PR322: 10K/0402
- PC168: X7R 1nF/50V 0603;
- PR200: 150K/0805;
- PR223: 1M/0402;
- PR324: 20K/0402
- PC193: X7R 220pF/200V 0805 三星;
- PR341: 10R/1206;
- 保留位置, 默认不装